

Vishay Siliconix

### P-Channel 20-V (D-S) MOSFET

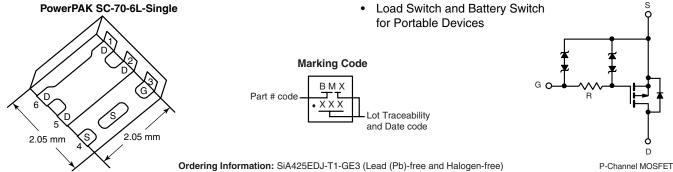
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω <b>)</b>	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)			
- 20	0.060 at V <sub>GS</sub> = - 4.5 V	- 4.5 <sup>a</sup>				
	0.065 at V <sub>GS</sub> = - 3.6 V	- 4.5 <sup>a</sup>	4.9 nC			
	0.080 at $V_{GS}$ = - 2.5 V	- 4.5 <sup>a</sup>	4.9110			
	0.120 at V <sub>GS</sub> = - 1.8 V	- 2				

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- New Thermally Enhanced PowerPAK® SC-70 Package
  - Small Footprint Area
  - Low On-Resistance
- Typical ESD Protection 2400 V
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

· Load Switch and Battery Switch for Portable Devices



ABSOLUTE MAXIMUM RATINGS	<b>S</b> T <sub>A</sub> = 25 °C, unles	ss otherwise not	ed		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	- 20	V	
Gate-Source Voltage		V <sub>GS</sub>	± 12		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C T <sub>C</sub> = 70 °C	_	- 4.5 <sup>a</sup> - 4.5 <sup>a</sup>	_	
	$T_{A} = 25 \text{ °C}$ $T_{A} = 70 \text{ °C}$		- 4.5 <sup>a, b, c</sup> - 4.5 <sup>a, b, c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	- 15		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 4.5 <sup>a</sup> - 2.4 <sup>b, c</sup>	-	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C T <sub>C</sub> = 70 °C	P <sub>D</sub>	15.6 10	w	
iviaximum rower Dissipation	T <sub>A</sub> = 25 °C T <sub>A</sub> = 70 °C	- U -	2.9 <sup>b, c</sup> 1.8 <sup>b, c</sup>		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>		Ŭ .	260		

#### THERMAL RESISTANCE RATINGS Symbol Parameter Typical Maximum Unit 32 43 $t \le 5 s$ R<sub>thJA</sub> Maximum Junction-to-Ambient<sup>b, f</sup> °C/W Steady State Maximum Junction-to-Case (Drain) R<sub>thJC</sub> 6 8

Notes:

a. Package limited.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. See Solder Profile (<u>www.vishay.com/ppg?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under Steady State conditions is 80 °C/W.



COMPLIANT

HALOGEN FREE

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = - 250 µA	- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	– I <sub>D</sub> = - 250 μΑ		- 15		- mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			2.6			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 0.4		- 1	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$			± 4	μΑ	
Gale-Source Leakage		$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 8	mA	
Zara Cata Valtaga Drain Current	I <sub>DSS</sub>	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μA	
Zero Gate Voltage Drain Current		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le$ - 5 V, $V_{GS}$ = - 4.5 V	- 10			Α	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -4.2 \text{ A}$		0.050	0.06	- Ω	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 3.6 V, I <sub>D</sub> = - 4.0 A		0.053	0.065		
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 3.6 A		0.065	0.080		
		V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 2 A		0.091	0.120		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 4.2 A		15		S	
Dynamic <sup>b</sup>				<b>I</b>			
Gate Resistance	R <sub>g</sub>	f = 1 MHz	1.2	6	12	kΩ	
Turn-On Delay Time	t <sub>d(on)</sub>			1.2	2.4	μs	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_{L}$ = 2.2 $\Omega$		5	10		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 4.5 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		14	28		
Fall Time	t <sub>f</sub>	-		10	20		
Turn-On Delay Time	t <sub>d(on)</sub>			0.5	1		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_{L}$ = 2.2 $\Omega$		1.4	2.8		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 4.5 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		20	40		
Fall Time	t <sub>f</sub>			10	20		
Drain-Source Body Diode Characteristi	cs			<b>I</b>			
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 4.5	٨	
Pulse Diode Forward Current	I <sub>SM</sub>				- 15	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 4.5 A, V <sub>GS</sub> = 0 V		- 0.9	- 1.2	V	
Body Diode Reverse Recovery Time t <sub>rr</sub>				20	40	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			11	20	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	I <sub>F</sub> = - 4.5 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C -		12		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			8			

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

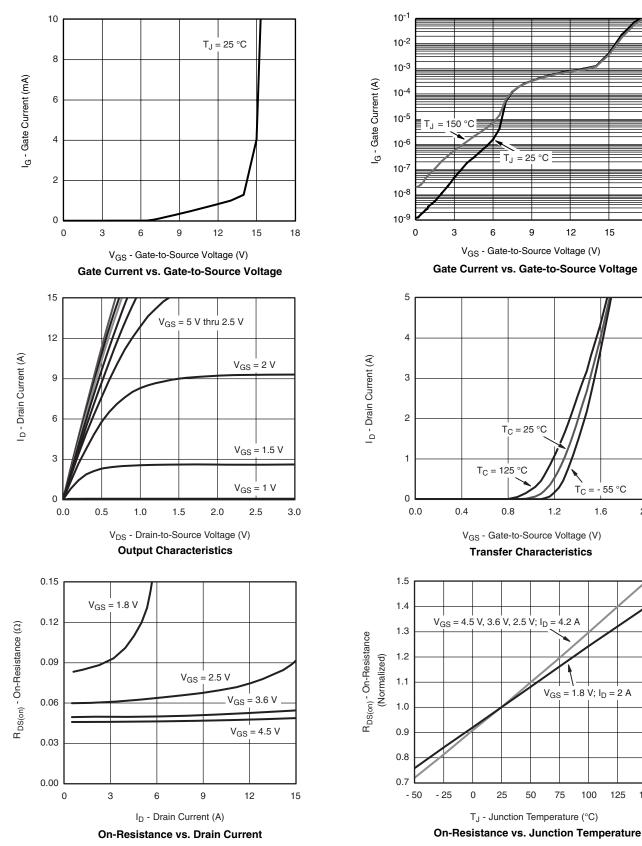


### SiA425EDJ Vishay Siliconix

18

2.0

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

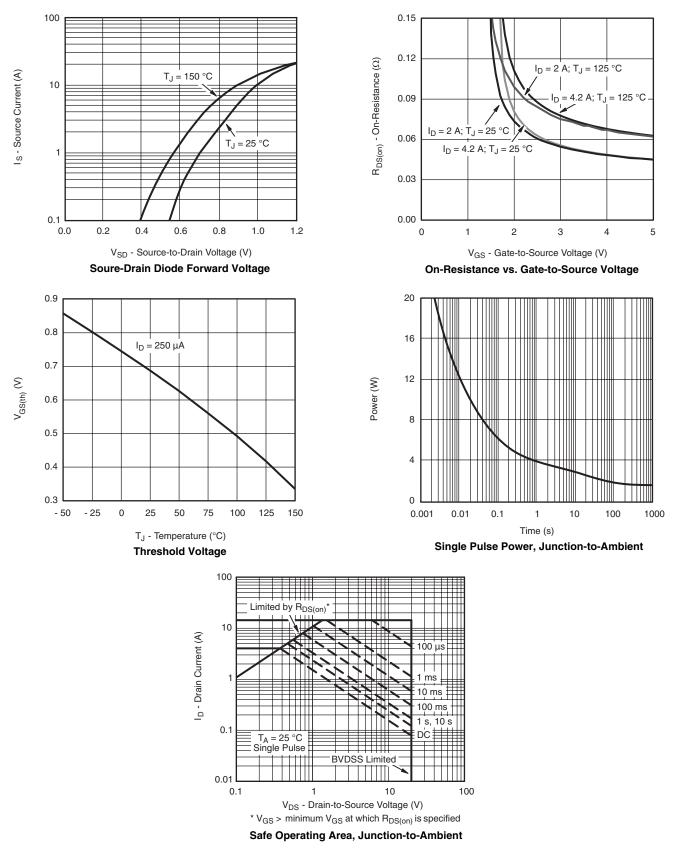


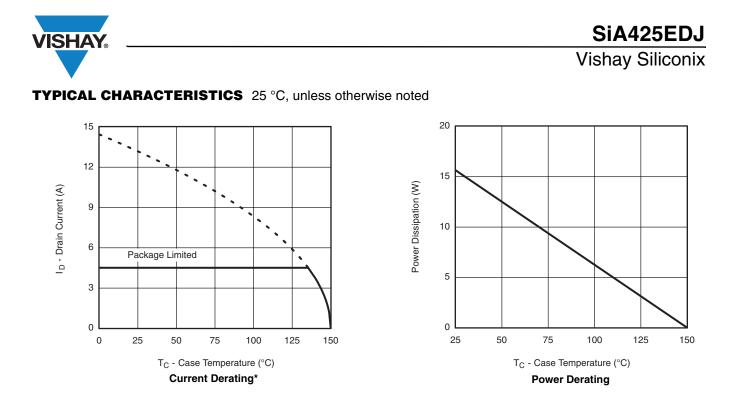
150



### Vishay Siliconix

### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



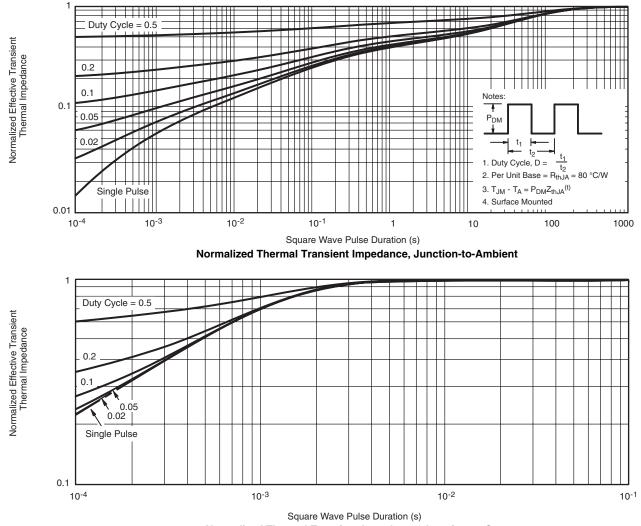


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?65575">www.vishay.com/ppg?65575</a>.



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